



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

MCH3481 — Low Voltage Drive Switching Device Applications

Features

- ON-resistance $R_{DS(on)1}=80m\Omega$ (typ.)
- Halogen free compliance
- 1.2V drive
- Protection diode in

Specifications

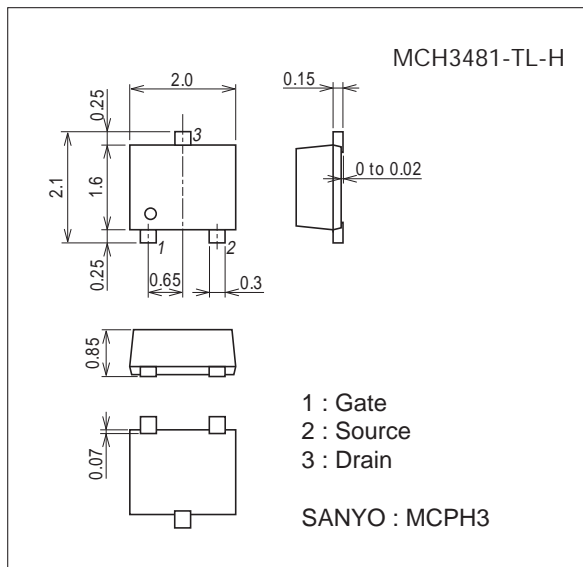
Absolute Maximum Ratings at $T_a=25^\circ C$

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V_{DSS}		20	V
Gate-to-Source Voltage	V_{GSS}		± 9	V
Drain Current (DC)	I_D		2	A
Drain Current (Pulse)	I_{DP}	$PW \leq 10\mu s$, duty cycle $\leq 1\%$	8	A
Allowable Power Dissipation	P_D	When mounted on ceramic substrate (900mm ² x0.8mm)	0.8	W
Channel Temperature	T_{ch}		150	$^\circ C$
Storage Temperature	T_{stg}		-55 to +150	$^\circ C$

Package Dimensions

unit : mm (typ)

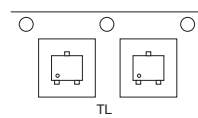
7019A-003



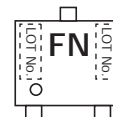
Product & Package Information

- Package : MCPH3
- JEITA, JEDEC : SC-70, SOT-323
- Minimum Packing Quantity : 3,000 pcs./reel

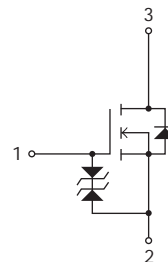
Packing Type : TL



Marking



Electrical Connection

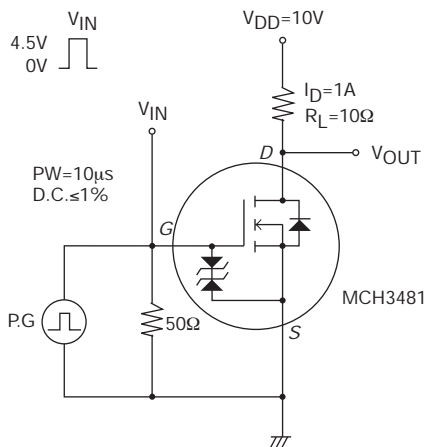


MCH3481

Electrical Characteristics at Ta=25°C

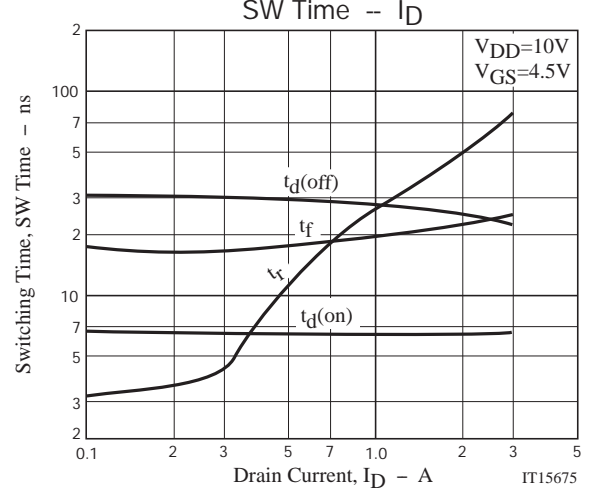
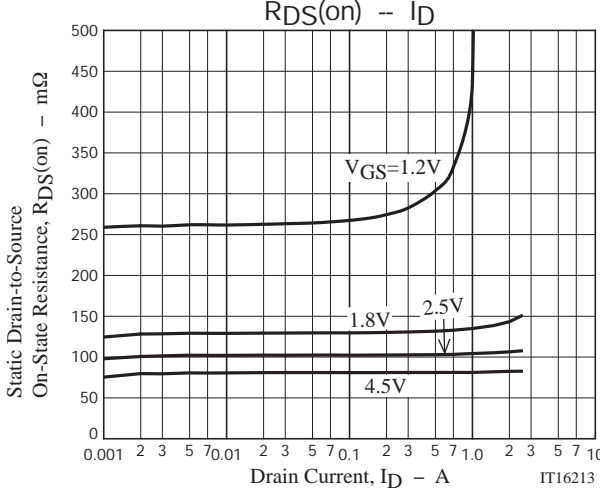
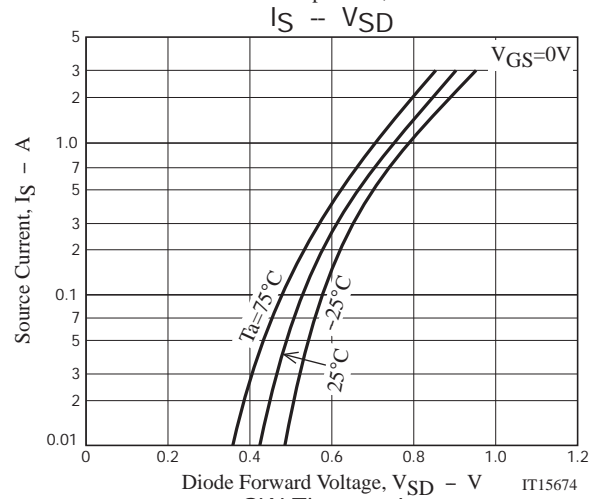
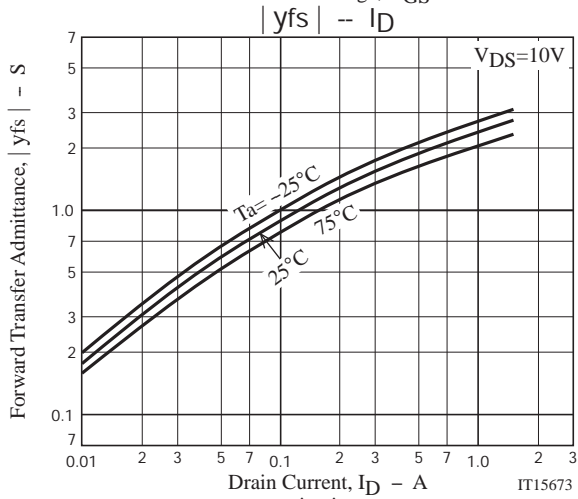
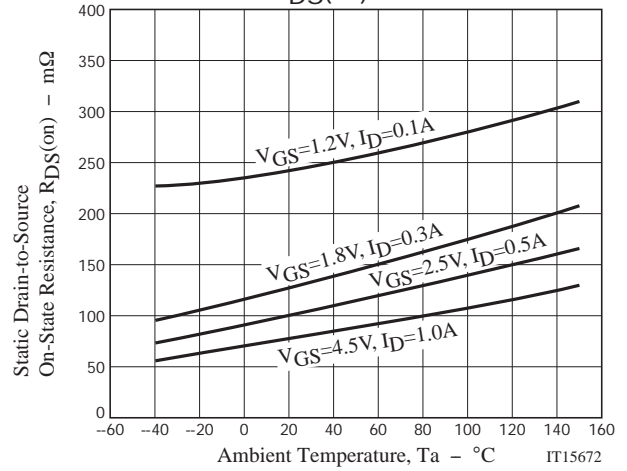
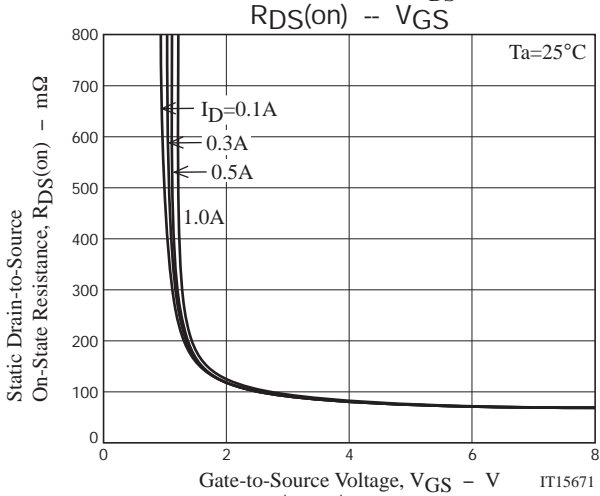
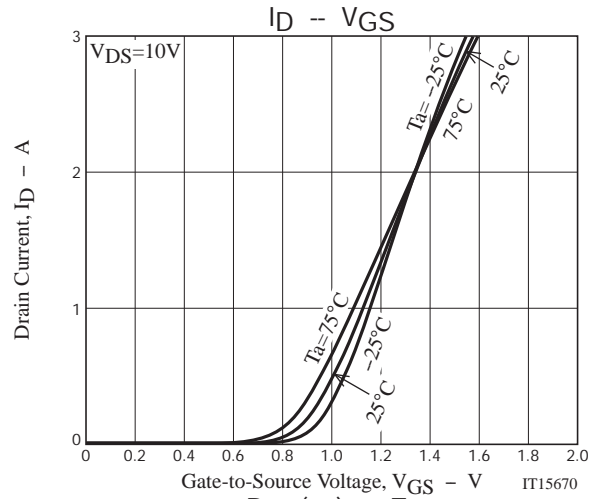
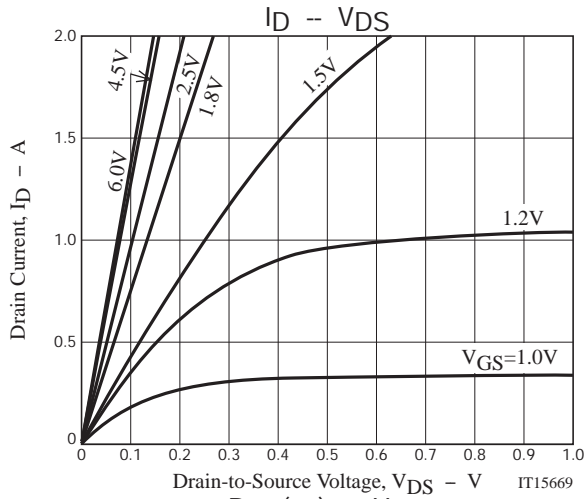
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	V(BR)DSS	I _D =1mA, V _{GS} =0V	20			V
Zero-Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V			1	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} =±7.2V, V _{DS} =0V			±10	μA
Cutoff Voltage	V _{GS(off)}	V _{DS} =10V, I _D =1mA	0.3		0.9	V
Forward Transfer Admittance	y _{fs}	V _{DS} =10V, I _D =1A		2.4		S
Static Drain-to-Source On-State Resistance	R _{DS(on)1}	I _D =1A, V _{GS} =4.5V		80	104	mΩ
	R _{DS(on)2}	I _D =0.5A, V _{GS} =2.5V		105	147	mΩ
	R _{DS(on)3}	I _D =0.3A, V _{GS} =1.8V		135	203	mΩ
	R _{DS(on)4}	I _D =0.1A, V _{GS} =1.2V		270	540	mΩ
Input Capacitance	C _{iss}	V _{DS} =10V, f=1MHz		175		pF
Output Capacitance	C _{oss}			30		pF
Reverse Transfer Capacitance	C _{rss}			25		pF
Turn-ON Delay Time	t _{d(on)}		See specified Test Circuit.		6.6	
Rise Time	t _r			27		ns
Turn-OFF Delay Time	t _{d(off)}			28		ns
Fall Time	t _f			19		ns
Total Gate Charge	Q _g	V _{DS} =10V, V _{GS} =4.5V, I _D =2A			2.9	
Gate-to-Source Charge	Q _{gs}			0.46		nC
Gate-to-Drain "Miller" Charge	Q _{gd}			0.53		nC
Diode Forward Voltage	V _{SD}	I _S =2A, V _{GS} =0V		0.85	1.2	V

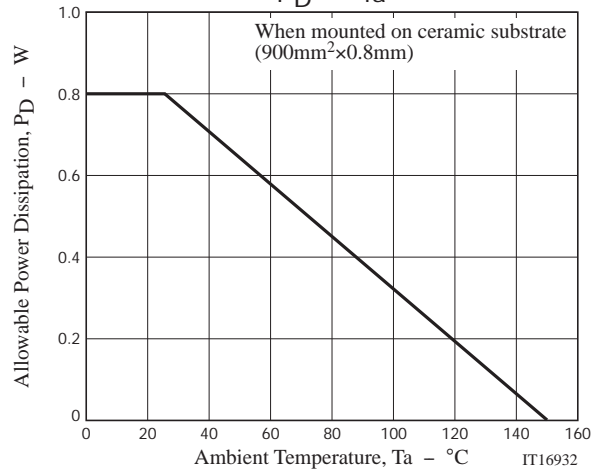
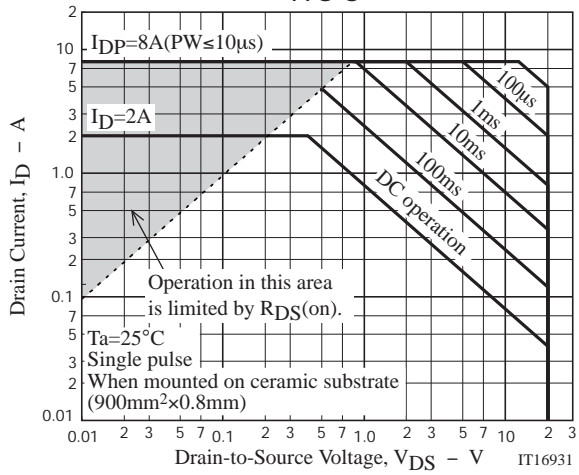
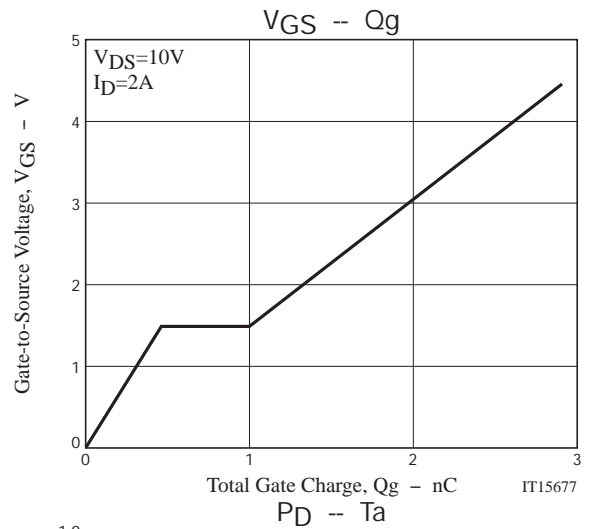
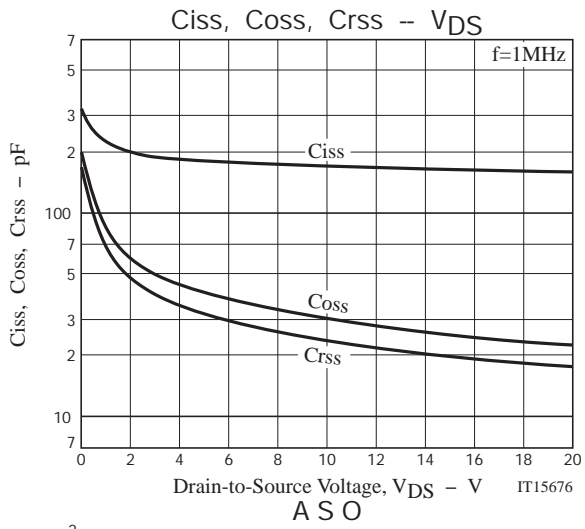
Switching Time Test Circuit



Ordering Information

Device	Package	Shipping	memo
MCH3481-TL-H	MCPH3	3,000pcs./reel	Pb Free and Halogen Free





Taping Specification

MCH3481-TL-H

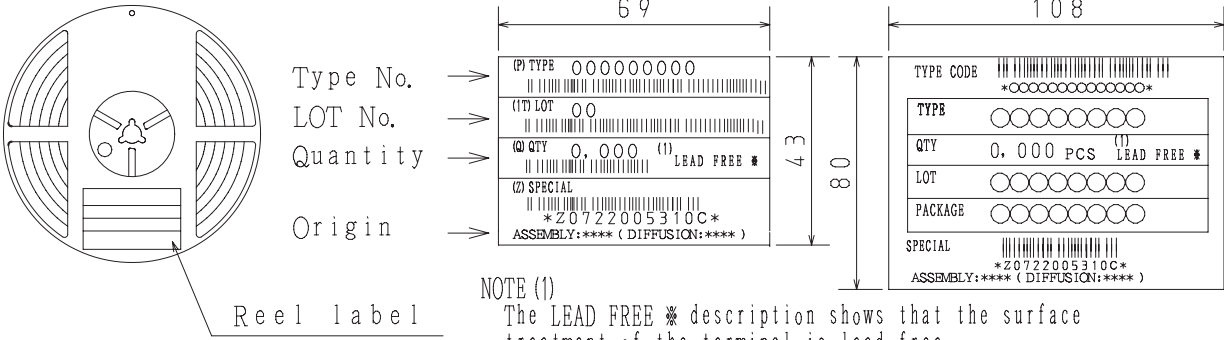
1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
MCPH3	MCPH3	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Packing method

Reel label, Inner box label (unit:mm) Outer box label

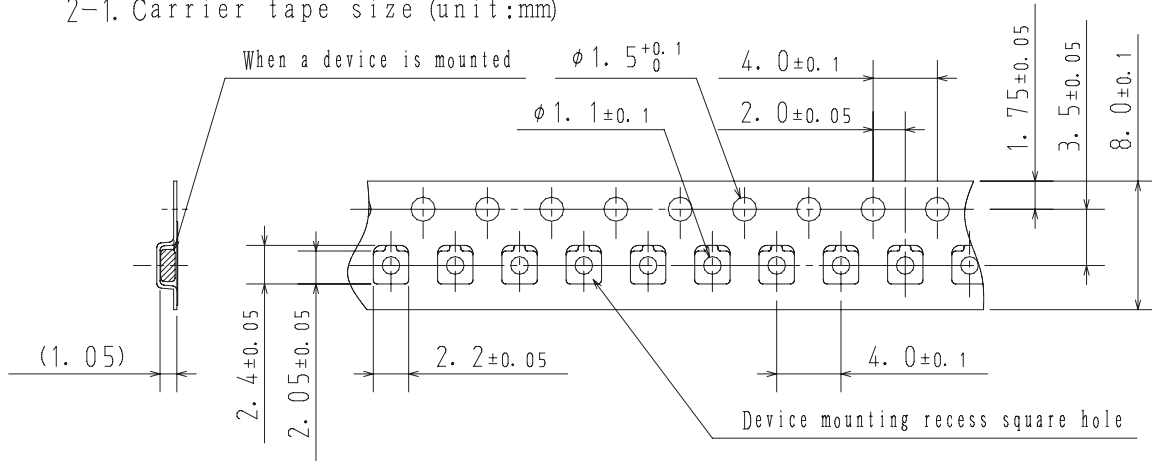
It is a label at the time of factory shipments. The form of a label may change in physical distribution process.



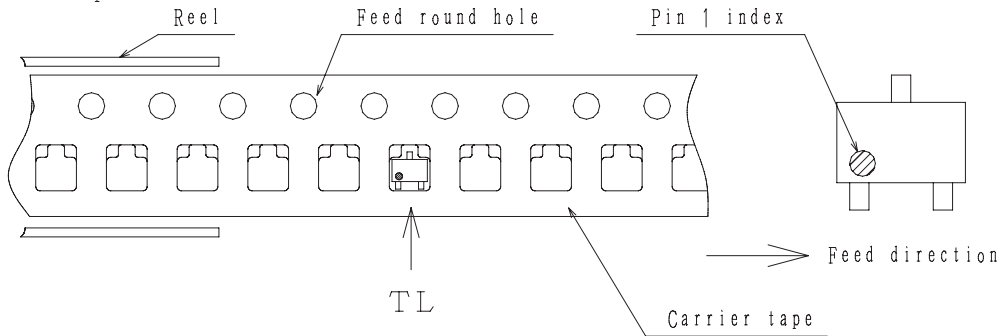
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



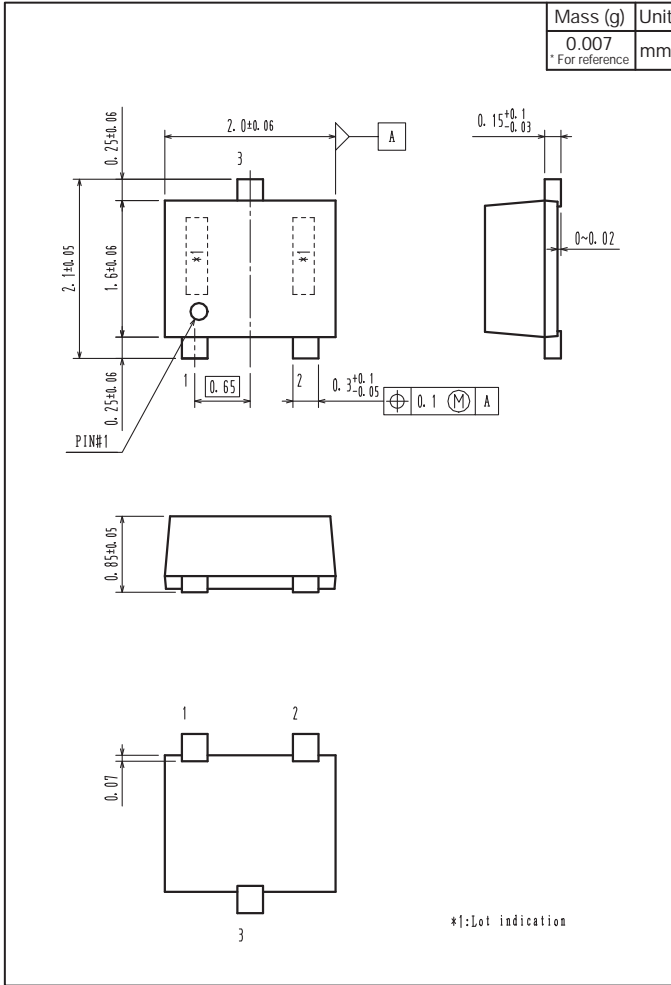
2-2. Device placement direction



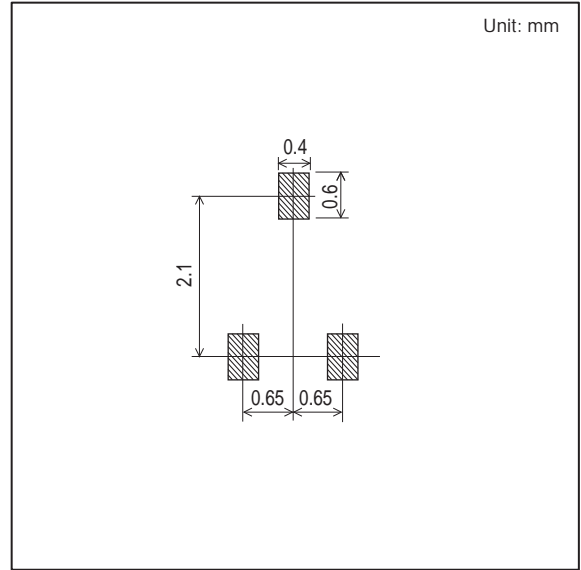
Those with pin 1 index on the feed hole side.....TL

MCH3481

Outline Drawing MCH3481-TL-H



Land Pattern Example



Note on usage : Since the MCH3481 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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